Commissioner for Patents Washington, D.C. 20231

ENHANCED RESISTANCE TO ELECTROSTATIC BREAKDOWN

Sir:

AMENDMENT UNDER 37 C.F.R. § 1.111 AND REQUEST FOR RECONSIDERATION

In response to the Office Action dated November 4, 2002 (Paper No. 6), the period for response to which extends through February 4, 2003, please amend the above identified application as follows:

IN THE ABSTRACT:

Please amend the abstract as follows:

A semiconductor integrated circuit device having a plurality of internal circuits connected to different power lines, and an inter-circuit signal wire or a branched wire along these internal circuits, wherein near an active element in a first connection configuration connected to the inter-circuit signal wire or the like, a plurality of active elements in a second connection configuration are arranged to sandwich or surround the active element in the first connection configuration.

